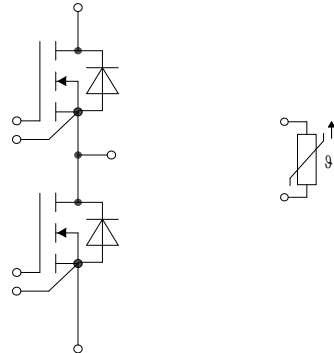
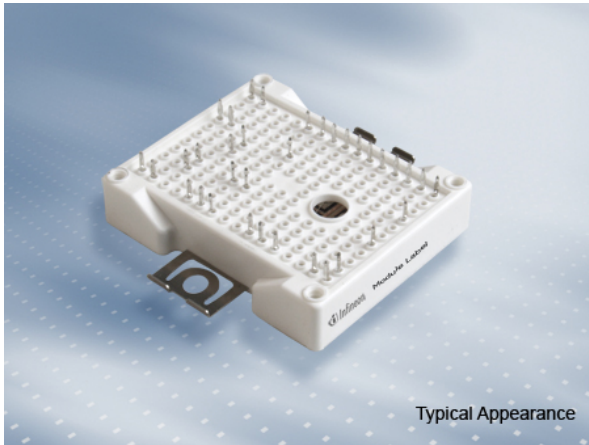


EasyDUAL 模块 采用 CoolSiC™ Trench MOSFET 带有pressfit压接管脚和温度检测NTC  
 EasyDUAL module with CoolSiC™ Trench MOSFET and PressFIT / NTC

初步数据 / Preliminary Data



$V_{DSS} = 1200V$   
 $I_{D\ nom} = 200A / I_{DRM} = 400A$

### 潜在应用

- DC/DC 变换器
- UPS系统
- 太阳能应用
- 高频开关应用

### Potential Applications

- DC/DC converter
- UPS systems
- Solar applications
- High Frequency Switching application

### 电气特性

- 低开关损耗
- 低电感设计
- 高电流密度

### Electrical Features

- Low switching losses
- Low inductive design
- High current density

### 机械特性

- PressFIT 压接技术
- 集成NTC温度传感器
- 集成的安装夹使安装坚固

### Mechanical Features

- PressFIT contact technology
- Integrated NTC temperature sensor
- Rugged mounting due to integrated mounting clamps

## Module Label Code

Barcode Code 128



DMX - Code



Content of the Code

| Content of the Code        | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

初步数据  
 Preliminary Data

## MOSFET / MOSFET

## 最大额定值 / Maximum Rated Values

|                                |   |                            |                      |          |
|--------------------------------|---|----------------------------|----------------------|----------|
| 漏源极电压<br>Drain-source voltage  | $T_{vj} = 25^{\circ}\text{C}$   | $V_{DSS}$                  | 1200                 | V        |
| 直流漏极电流<br>DC drain current     | $T_{vj} = 175^{\circ}\text{C}, V_{GS} = 15\text{ V}$  | $T_H = 10^{\circ}\text{C}$ | $I_{D\text{ nom}}$   | 200<br>A |
| 脉冲漏极电流<br>Pulsed drain current | 经设计验证, $t_p$ 由 $T_{vj\text{ max}}$ 限定<br>verified by design, $t_p$ limited by $T_{vj\text{ max}}$ |                            | $I_{D\text{ pulse}}$ | 400<br>A |
| 栅源峰值电压<br>Gate-source voltage  |   | $V_{GSS}$                  | -10 / 20             | V        |

## 特征值 / Characteristic Values

|   |  |   | min.               | typ.                 | max. |                    |
|---|--|---|--------------------|----------------------|------|--------------------|
| 漏源通态电阻<br>Drain-source on resistance                  | $I_D = 200\text{ A}$<br>$V_{GS} = 15\text{ V}$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $R_{DS\text{ on}}$ | 5,63<br>7,38<br>8,25 |      | m $\Omega$         |
| 栅极阈值电压<br>Gate threshold voltage                      | $I_D = 80,0\text{ mA}, V_{DS} = V_{GS}, T_{vj} = 25^{\circ}\text{C}$<br>(tested after 1ms pulse at $V_{GS} = +20\text{ V}$ )   |   | $V_{GS(th)}$       | 3,45<br>4,50<br>5,55 |      | V                  |
| 总的栅极电荷<br>Total gate charge                           | $V_{GS} = -5\text{ V} / 15\text{ V}, V_{DS} = 800\text{ V}$  |   | $Q_G$              | 0,496                |      | $\mu\text{C}$      |
| 内部栅极电阻<br>Internal gate resistor                      | $T_{vj} = 25^{\circ}\text{C}$  |   | $R_{Gint}$         | 0,5                  |      | $\Omega$           |
| 输入电容<br>Input capacitance                             | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}$<br>$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}, V_{AC} = 25\text{ mV}$   |   | $C_{iss}$          | 14,7                 |      | nF                 |
| 输出电容<br>Output capacitance                            | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}$<br>$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}, V_{AC} = 25\text{ mV}$   |   | $C_{oss}$          | 0,88                 |      | nF                 |
| 反向传输电容<br>Reverse transfer capacitance                | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}$<br>$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}, V_{AC} = 25\text{ mV}$   |   | $C_{rss}$          | 0,112                |      | nF                 |
| $C_{oss}$ stored energy                               | $T_{vj} = 25^{\circ}\text{C}$<br>$V_{DS} = 800\text{ V}, V_{GS} = -5\text{ V} / 15\text{ V}$   |   | $E_{oss}$          | 352                  |      | $\mu\text{J}$      |
| 零栅电压漏极电流<br>Zero gate voltage drain current           | $V_{DS} = 1200\text{ V}, V_{GS} = -5\text{ V}$   | $T_{vj} = 25^{\circ}\text{C}$   | $I_{DSS}$          | 0,80                 | 660  | $\mu\text{A}$      |
| 栅极漏电流<br>Gate-source leakage current                  | $V_{DS} = 0\text{ V}$<br>$T_{vj} = 25^{\circ}\text{C}$   | $V_{GS} = 20\text{ V}$<br>$V_{GS} = -10\text{ V}$   | $I_{GSS}$          |                      | 400  | nA                 |
| 开通延迟时间(电感负载)<br>Turn on delay time, inductive load    | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}$<br>$V_{GS} = -5\text{ V} / 15\text{ V}$<br>$R_{Gon} = 1,80\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_{d\text{ on}}$  | 20,4<br>19,3<br>18,8 |      | ns                 |
| 上升时间(电感负载)<br>Rise time, inductive load               | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}$<br>$V_{GS} = -5\text{ V} / 15\text{ V}$<br>$R_{Gon} = 1,80\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_r$              | 18,7<br>18,0<br>18,0 |      | ns                 |
| 关断延迟时间(电感负载)<br>Turn off delay time, inductive load   | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}$<br>$V_{GS} = -5\text{ V} / 15\text{ V}$<br>$R_{Goff} = 1,80\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_{d\text{ off}}$ | 62,6<br>66,0<br>66,0 |      | ns                 |
| 下降时间(电感负载)<br>Fall time, inductive load               | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}$<br>$V_{GS} = -5\text{ V} / 15\text{ V}$<br>$R_{Goff} = 1,80\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_f$              | 30,0<br>30,5<br>30,5 |      | ns                 |
| 开通损耗(每脉冲)<br>Turn-on energy loss per pulse            | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}, L_{\sigma} = 35\text{ nH}$<br>$di/dt = 13,0\text{ kA}/\mu\text{s}$ ( $T_{vj} = 150^{\circ}\text{C}$ )<br>$V_{GS} = -5\text{ V} / 15\text{ V}, R_{Gon} = 1,80\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $E_{on}$           | 2,50<br>2,70<br>2,90 |      | mJ                 |
| 关断损耗(每脉冲)<br>Turn-off energy loss per pulse           | $I_D = 200\text{ A}, V_{DS} = 600\text{ V}, L_{\sigma} = 35\text{ nH}$<br>$du/dt = 24,0\text{ kV}/\mu\text{s}$ ( $T_{vj} = 150^{\circ}\text{C}$ )<br>$V_{GS} = -5\text{ V} / 15\text{ V}, R_{Goff} = 1,80\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $E_{off}$          | 1,20<br>1,30<br>1,30 |      | mJ                 |
| 短路数据<br>SC data                                       | $V_{GS} = -5\text{ V} / 15\text{ V}, V_{DD} = 800\text{ V}$<br>$V_{DS\text{ max}} = V_{DSS} - L_{SDS} \cdot di/dt$<br>$R_G = 10,0\ \Omega$   | $t_p \leq 2\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$<br>$t_p \leq 2\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$           | 1680<br>1640         |      | A<br>A             |
| 结 - 散热器热阻<br>Thermal resistance, junction to heatsink | 每个MOSFET / per MOSFET  |   | $R_{thJH}$         | 0,328                |      | K/W                |
| 在开关状态下温度<br>Temperature under switching conditions    |  |   | $T_{vj\text{ op}}$ | -40                  | 150  | $^{\circ}\text{C}$ |

## Body diode

## 最大额定值 / Maximum Rated Values

|                               |  |                            |          |    |   |
|-------------------------------|--|----------------------------|----------|----|---|
| DC body diode forward current | $T_{vj} = 175^{\circ}\text{C}, V_{GS} = -5\text{ V}$ | $T_H = 10^{\circ}\text{C}$ | $I_{SD}$ | 64 | A |
|-------------------------------|--|----------------------------|----------|----|---|

## 特征值 / Characteristic Values

|                         |   |   | min.     | typ.                 | max. |   |
|-------------------------|---|---|----------|----------------------|------|---|
| 正向电压<br>Forward voltage | $I_{SD} = 200\text{ A}, V_{GS} = -5\text{ V}$<br>$I_{SD} = 200\text{ A}, V_{GS} = -5\text{ V}$<br>$I_{SD} = 200\text{ A}, V_{GS} = -5\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_{SD}$ | 4,60<br>4,35<br>4,30 | 5,65 | V |

初步数据  
Preliminary Data

负温度系数热敏电阻 / NTC-Thermistor  
特征值 / Characteristic Values

|                              |  | min.         |    | typ. |   | max. |                  |
|------------------------------|--|--------------|----|------|---|------|------------------|
| 额定电阻值<br>Rated resistance    | $T_{NTC} = 25^{\circ}\text{C}$                                 | $R_{25}$     |    | 5,00 |   |      | $\text{k}\Omega$ |
| R100 偏差<br>Deviation of R100 | $T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493 \Omega$          | $\Delta R/R$ | -5 |      | 5 |      | %                |
| 耗散功率<br>Power dissipation    | $T_{NTC} = 25^{\circ}\text{C}$                                 | $P_{25}$     |    |      |   | 20,0 | mW               |
| B-值<br>B-value               | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/50}$  |    | 3375 |   |      | K                |
| B-值<br>B-value               | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/80}$  |    | 3411 |   |      | K                |
| B-值<br>B-value               | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ | $B_{25/100}$ |    | 3433 |   |      | K                |

根据应用手册标定

Specification according to the valid application note.

模块 / Module

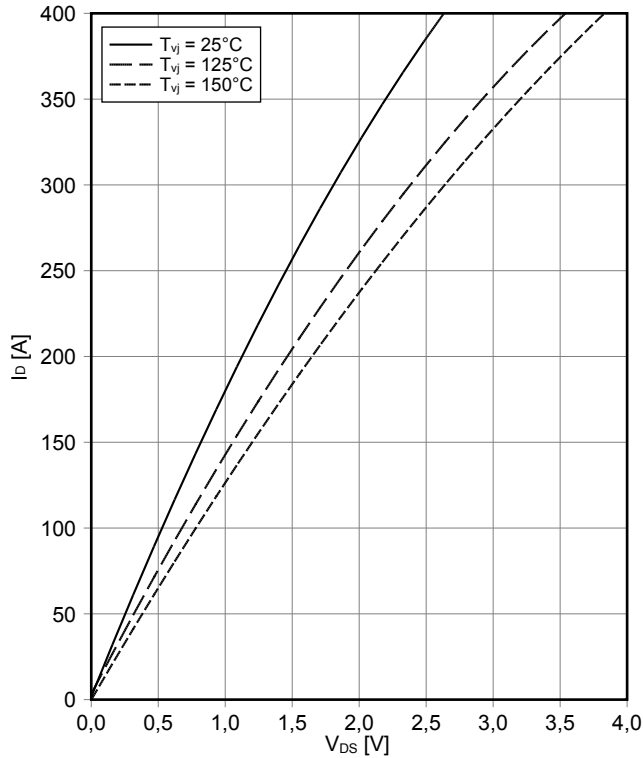
|   |  |                            |     |                         |     |      |                    |      |  |
|---|--|----------------------------|-----|-------------------------|-----|------|--------------------|------|--|
| 绝缘测试电压<br>Isolation test voltage                                  | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min.}$                    | $V_{\text{ISOL}}$          |     | 3,0                     |     |      | kV                 |      |  |
| 内部绝缘<br>Internal isolation  | 基本绝缘 (class 1, IEC 61140)<br>basic insulation (class 1, IEC 61140) |                            |     | $\text{Al}_2\text{O}_3$ |     |      |                    |      |  |
| 爬电距离<br>Creepage distance   | 端子至散热器 / terminal to heatsink<br>端子至端子 / terminal to terminal      |                            |     | 11,5<br>6,3             |     |      | mm                 |      |  |
| 电气间隙<br>Clearance   | 端子至散热器 / terminal to heatsink<br>端子至端子 / terminal to terminal      |                            |     | 10,0<br>5,0             |     |      | mm                 |      |  |
| 相对电痕指数<br>Comperative tracking index                              |  | CTI                        |     | > 200                   |     |      |                    |      |  |
| 相对温度指数 (电)<br>RTI Elec.   | 住房<br>housing  | RTI                        |     | 140                     |     |      | $^{\circ}\text{C}$ |      |  |
|   |  |                            |     | min.                    |     | typ. |                    | max. |  |
| 杂散电感, 模块<br>Stray inductance module                               |  | $L_{\text{sCE}}$           |     | 8,0                     |     |      | nH                 |      |  |
| 模块引线电阻, 端子-芯片<br>Module lead resistance, terminals - chip         | $T_{\text{H}} = 25^{\circ}\text{C}$ , 每个开关 / per switch            | $R_{\text{CC}+\text{EE}'}$ |     | 0,50                    |     |      | $\text{m}\Omega$   |      |  |
| 储存温度<br>Storage temperature                                       |  | $T_{\text{stg}}$           | -40 |                         | 125 |      | $^{\circ}\text{C}$ |      |  |
| Anpresskraft für mech. Bef. pro Feder<br>mounting force per clamp |  | F                          | 40  | -                       | 80  |      | N                  |      |  |
| 重量<br>Weight  |  | G                          |     | 39                      |     |      | g                  |      |  |

The current under continuous operation is limited to 25 A rms per connector pin.

Important note: The selection of positive and negative gate-source voltages impacts the long-term behavior of the device. The design guidelines described in AN 2018-09 must be considered to ensure sound operation of the device over the planned lifetime.

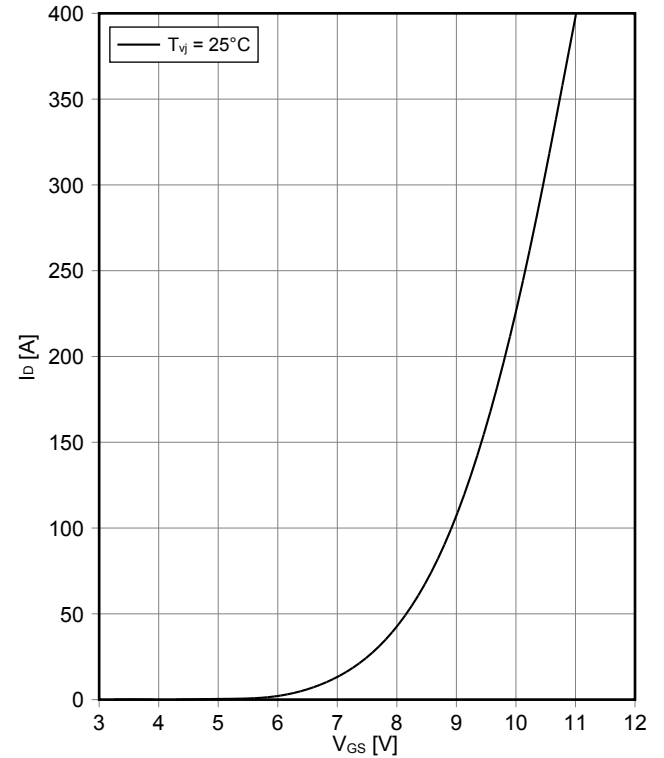
输出特性 MOSFET (典型)  
output characteristic MOSFET (typical)

$I_D = f(V_{DS})$   
 $V_{GS} = 15\text{ V}$



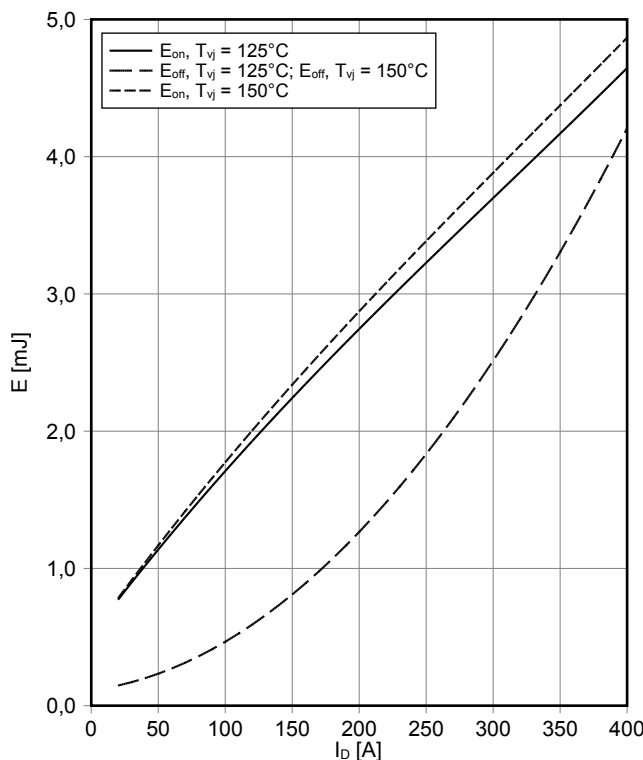
传输特性 MOSFET (典型)  
transfer characteristic MOSFET (typical)

$I_D = f(V_{GS})$   
 $V_{DS} = 20\text{ V}$



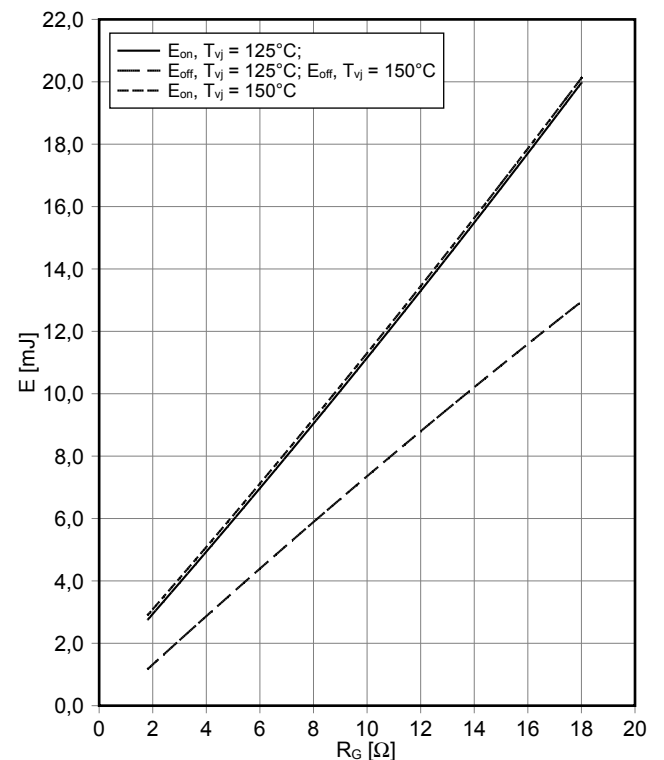
开关损耗 MOSFET (典型)  
switching losses MOSFET (typical)

$E_{on} = f(I_D), E_{off} = f(I_D)$   
 $V_{GS} = -5\text{ V} / 15\text{ V}, R_{Gon} = 1,8\ \Omega, R_{Goff} = 1,8\ \Omega, V_{DS} = 600\text{ V}$



开关损耗 MOSFET (典型)  
switching losses MOSFET (typical)

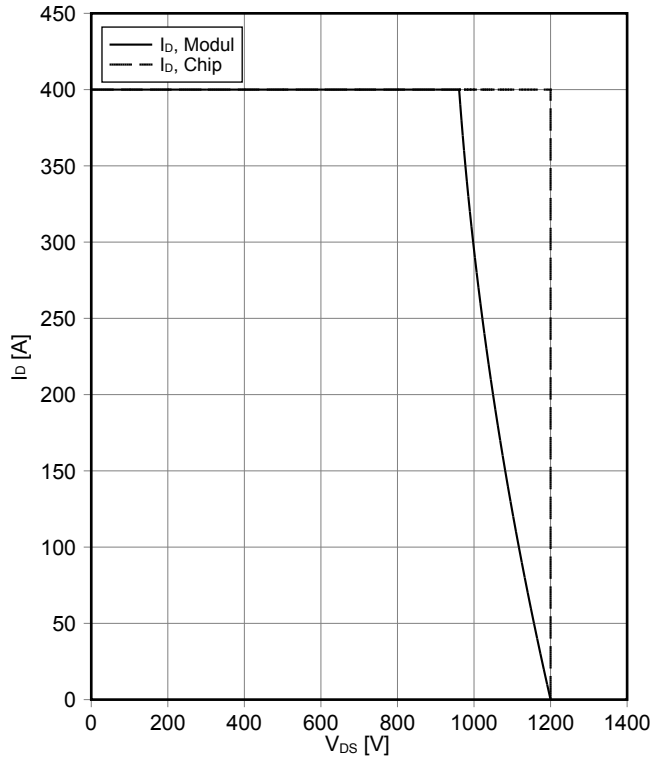
$E_{on} = f(R_G), E_{off} = f(R_G)$   
 $V_{GS} = -5\text{ V} / 15\text{ V}, I_D = 200\text{ A}, V_{DS} = 600\text{ V}$



## 初步数据 Preliminary Data

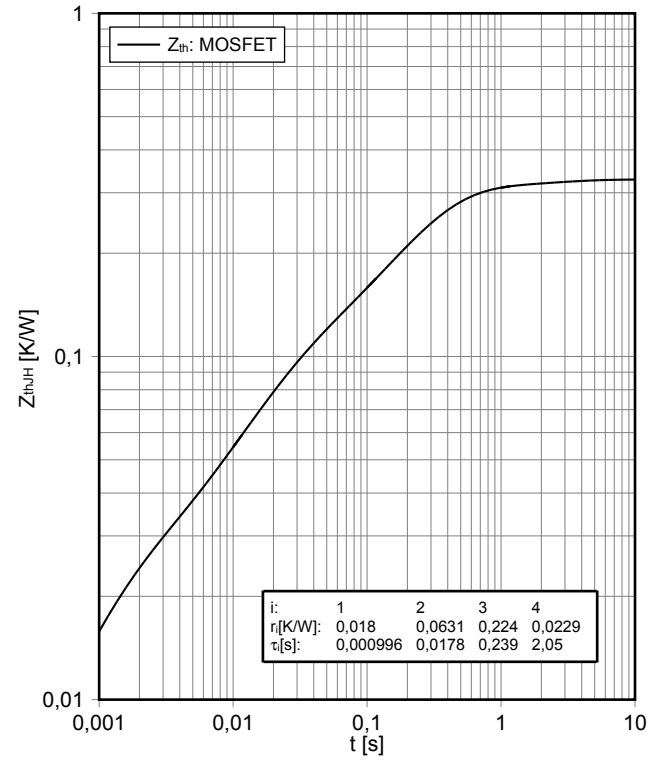
反偏安全工作区 MOSFET (RBSOA)  
reverse bias safe operating area MOSFET (RBSOA)

$I_D = f(V_{DS})$   
 $V_{GS} = -5\text{ V} / 15\text{ V}$ ,  $T_{vj} = 150^\circ\text{C}$ ,  $R_G = 1,8\ \Omega$



瞬态热阻抗 MOSFET  
transient thermal impedance MOSFET

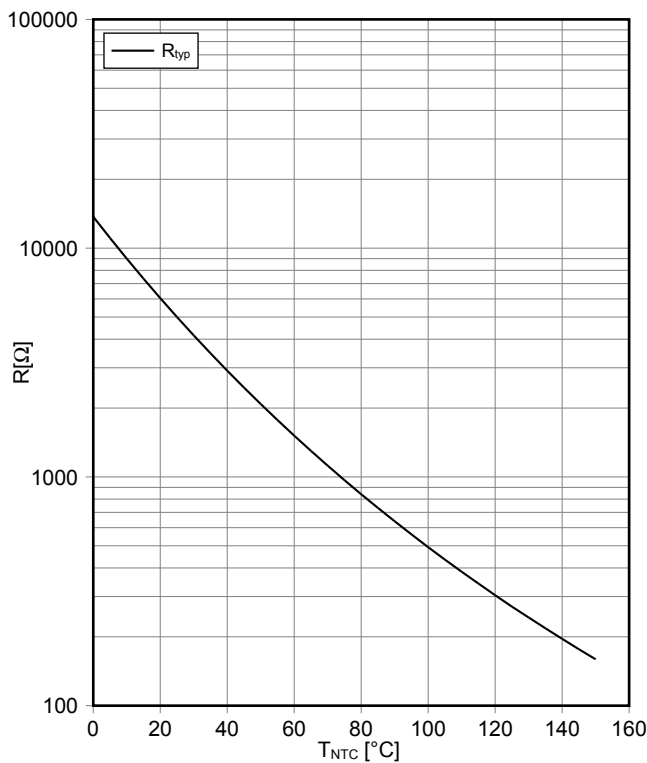
$Z_{thJH} = f(t)$



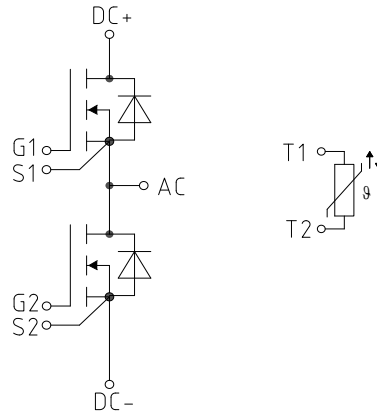
| i:            | 1        | 2      | 3     | 4      |
|---------------|----------|--------|-------|--------|
| $r_i$ [K/W]:  | 0,018    | 0,0631 | 0,224 | 0,0229 |
| $\tau_i$ [s]: | 0,000996 | 0,0178 | 0,239 | 2,05   |

负温度系数热敏电阻 温度特性  
NTC-Thermistor-temperature characteristic (typical)

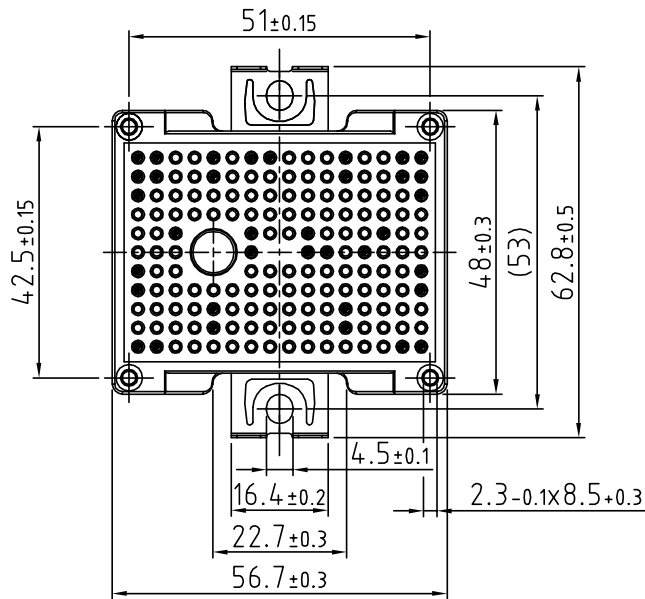
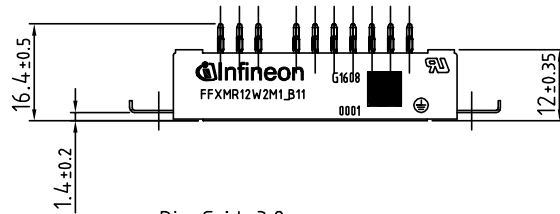
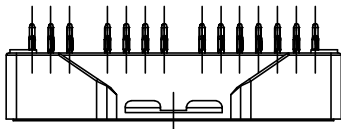
$R = f(T)$



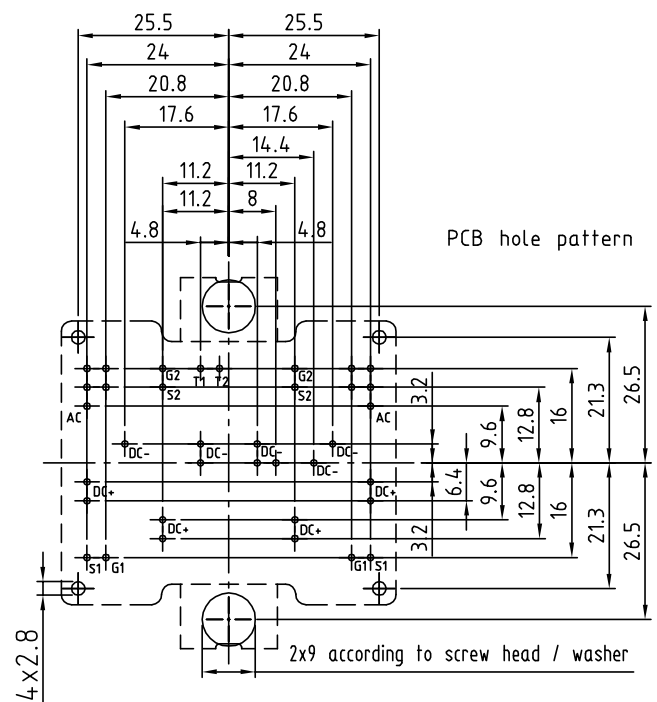
接线图 / Circuit diagram



封装尺寸 / Package outlines



- Pin-Grid 3.2mm
- Tolerance of PCB hole pattern  $\begin{matrix} \oplus \\ \ominus \end{matrix} \phi 0.1$
- Hole specification for contacts see AN 2009-01:  
Diameters of drill  $\phi 1.15\text{mm}$   
and copper thickness in hole 25-50 $\mu\text{m}$



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